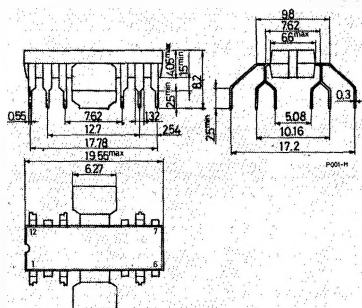
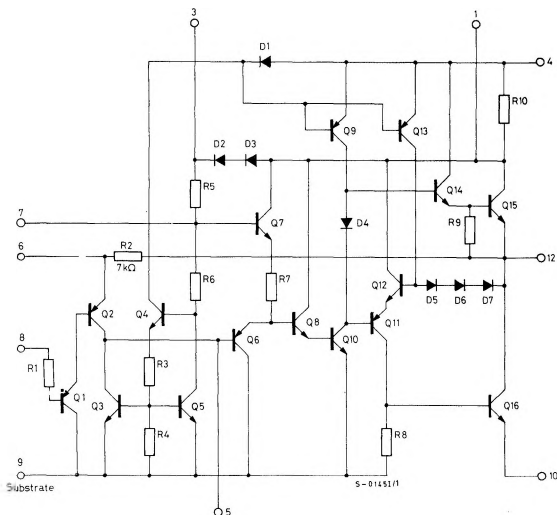
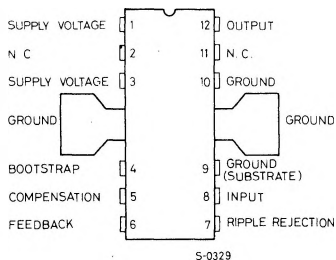




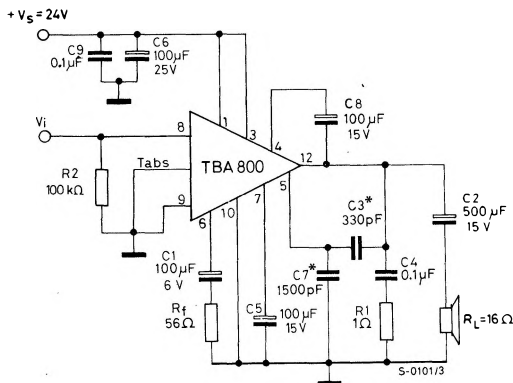
**TBA 800**

CONNECTION AND SCHEMATIC DIAGRAMS

(top view)



TEST CIRCUIT



* C_3 , C_7 see fig. 5.



THERMAL DATA

$R_{th\ j-tab}$	Thermal resistance junction-tab	max	12	°C/W
$R_{th\ j-amb}$	Thermal resistance junction-ambient	max	70*	°C/W

* Obtained with tabs soldered to printed circuit with minimized copper area.

ELECTRICAL CHARACTERISTICS (Refer to the test circuit, $T_{amb} = 25^{\circ}\text{C}$, $V_s = 24\text{V}$, $R_L = 16\Omega$, unless otherwise specified)

Parameter		Test conditions	Min.	Typ.	Max.	Unit
V _O	Quiescent output voltage (pin 12)		11	12	13	V
I _d	Quiescent drain current			9	20	mA
I _b	Input bias current (pin 8)			1	5	μA
P _O	Output power	d = 10% f = 1 kHz	4.4	5		W
V _{i(rms)}	Input saturation voltage		220			mV
V _i [*]	Input sensitivity	P _O = 5W f = 1 kHz		80		mV
R _i	Input resistance (pin 8)	f = 1 KHz		5		MΩ
B	Frequency response (−3 dB)	C3 = 330 pF	40 to 20,000			Hz
d	Distortion	P _O = 50 mW to 2.5W f = 1 kHz		0.5		%
G _v	Voltage gain (open loop)	f = 1 kHz		80		dB
G _v	Voltage gain (closed loop)	f = 1 kHz	39	42	45	dB
e _N	Input noise voltage	B = 22 Hz to 22 KHz		5		μV
i _N	Input noise current			0.2		nA
η	Efficiency	P _O = 5W f = 1 kHz		75		%
SVR	Supply voltage rejection	f _{ripple} = 100 Hz C5 = 25 μF C5 = 100 μF		35 38		dB dB
I _d	Drain current	P _O = 5W		280		mA

* See fig. 6.

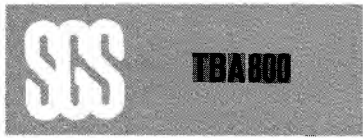


Fig. 1 - Output power vs. supply voltage

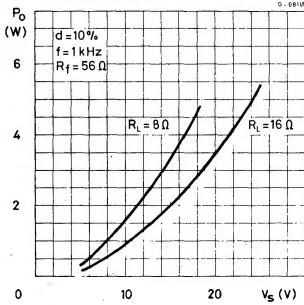


Fig. 2 - Maximum power dissipation vs. supply voltage

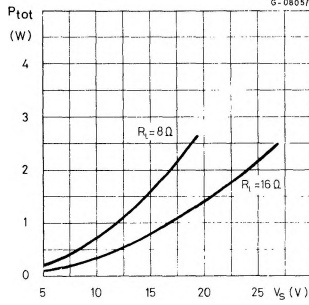


Fig. 3 - Distortion vs. output power

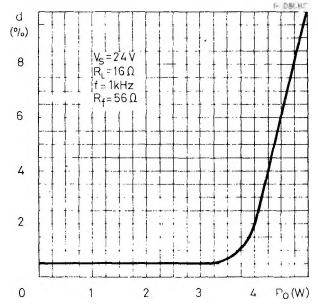


Fig. 4 - Distortion vs. frequency

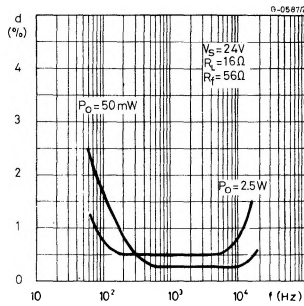


Fig. 5 - Value of C3 vs. RL for various values of B

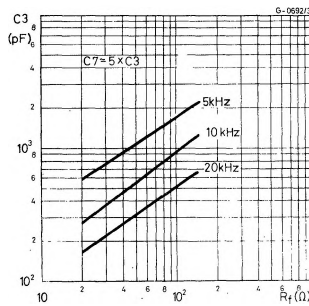


Fig. 6 - Voltage gain (closed loop) and input voltage vs. RL

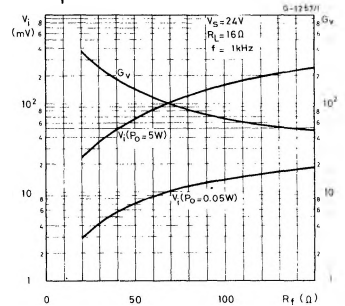


Fig. 7 - Power dissipation and efficiency vs. output power

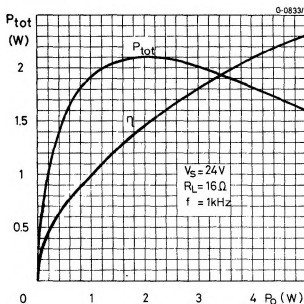


Fig. 8 - Quiescent output voltage (pin 12) vs. supply voltage

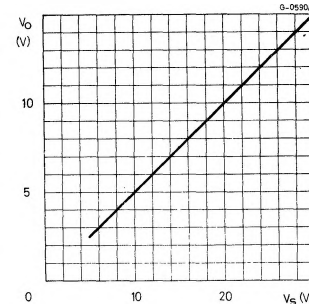
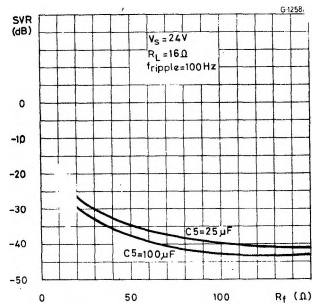
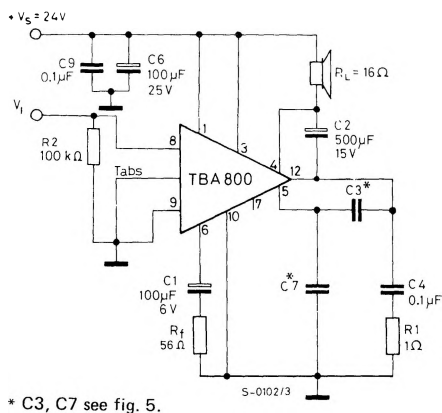


Fig. 9 - Supply voltage rejection vs. RL



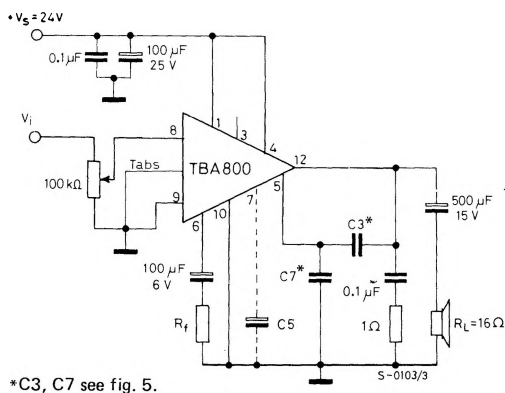
APPLICATION INFORMATION

Fig. 10 - Circuit with the load connected to the supply voltage



Compared with the other circuits, this configuration entails a lower number of external components and can be used at low supply voltages.

Fig. 11 - Circuit with load connected to ground without bootstrap.



This circuit is only for use at high voltages. The pin 3 is left open circuit, this automatically inserts diodes D2-D3 (see schematic diagram) and this enables a symmetrical wave to be obtained at the output.